EAST Search History

EAST Search History (Prior Art)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	329	moriceau-hubert.in. or aspar-bernard.in. or margail-jacques.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 10:48
S2	3782	(noncontinuous$ or (non adj continuous$) or ("non-continuous"$)) with (film or layer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 10:49
S3	1074	S2 semiconductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 10:50
S4	712	S2 ("438".clas. or "257".clas.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 10:51
S5	30	("6156215" | "20040222500" | "6146979" | "6417075" | "6974759" | "20020145489" | "20030077885" | "6764936" | "5259041" | "6198159" | "20050042842" | "20030119279" | "6902987").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 13:10
S6	4360	(second with substrate) with rough$	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 14:09
S7	3128	(second with substrate) with rough$ with surface	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 14:10
S8	2300	(second with substrate) with rough$	US-PGPUB;		AND		ON	2011/12/07

		near2 surface	USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB			14:10
S9	575	438/406.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 14:10
S10	9	S8 S9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 14:11
S11	311372	(rough$ or RMS) near2 surface	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 14:17
S12	375932	(rough$ or RMS or uneven or cragged or craggy or jagged or ridged or rocky or (("not" or non) adj uniform)) near2 surface	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 14:18
S13	145	S9 S12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 14:18
S14	2511	438/455.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 14:44
S15	1747	438/459.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 14:44
S16	490	438/311.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT;	AND	ON	2011/12/07 14:44

			IBM_TDB			
S17	758	438/756.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 14:44
S18	3782	S14 or S15	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 14:44
S19	968	S18 S12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 14:44
S20	899	S19 not S13	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 14:44
S21	64	S17 S12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/07 16:54
S22	575	438/406.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 14:57
S23	376210	(rough$ or RMS or uneven or cragged or craggy or jagged or ridged or rocky or (("not" or non) adj uniform)) near2 surface	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 14:57
S24	145	S22 S23	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 14:57
S25	5927	((first or second) with (substrate or wafer or plate or semiconductor)) with rough$ near2 surface	US-PGPUB; USPAT; USOCR; FPRS;	AND	ON	2011/12/12 15:15

			EPO; JPO; DERWENT; IBM_TDB			
S26	1556362	second with (substrate or wafer or plate or semiconductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 15:17
S27	5298	S25 S26	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 15:17
S28	3859	S25 with S26	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 15:17
S29	1011	S28.clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 15:17
S30	370995	second near (substrate or wafer or plate or semiconductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 15:18
S31	451782	first near (substrate or wafer or plate or semiconductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 15:18
S32	1402	((first or second) near (substrate or wafer or plate or semiconductor)) with rough$ near2 surface	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 15:19
S33	366	S32 same (etch$ or remov$5 or eliminat$)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 15:20
S34	153	S31 with S32 with (bond$4 or attach$4 or adher$7)	US-PGPUB; USPAT;	AND	ON	2011/12/12 15:23

			USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB			
S35	34	("20020017133" | "20020071169" | "20020195417" | "20040065638" | "20040102021" | "20040177689" | "20050081633" | "20050082252" | "20050166677" | "20050170656" | "20050172717" | "20060014358" | "20060101912" | "20060219006" | "20070012653" | "20080048211" | "20080115579" | "20100009514" | "20100026779" | "6084257" | "6316796" | "6773942" | "6892575" | "6939473" | "6946314" | "6988408" | "7104129" | "7223624" | "7238621" | "7247246" | "7250112" | "7335527" | "7458263" | "7621183").PN. OR ("7745308").URPN.	US-PGPUB; USPAT; USOCR	AND	ON	2011/12/12 15:50
S36	1170	438/50.ccls.	US-PGPUB; USPAT; USOCR	AND	ON	2011/12/12 15:55
S37	863	438/51.ccls.	US-PGPUB; USPAT; USOCR	AND	ON	2011/12/12 15:55
S38	978	438/52.ccls.	US-PGPUB; USPAT; USOCR	AND	ON	2011/12/12 15:56
S39	924	438/53.ccls.	US-PGPUB; USPAT; USOCR	AND	ON	2011/12/12 15:56
S40	3045	S36 or S37 or S38 or S39	US-PGPUB; USPAT; USOCR	AND	ON	2011/12/12 15:56
S41	5	S40 S32	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 15:57
S42	920	S40 S30	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 16:00
S43	726	S40 S30 S31	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 16:00
S44	2	S40 S34	US-PGPUB; USPAT; USOCR;	AND	ON	2011/12/12 16:00

			FPRS; EPO; JPO; DERWENT; IBM_TDB			
S45	556	S40 (S30 same S31)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 16:02
S46	202	S45 sacrificial	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 16:49
S47	2511	438/455.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 17:05
S48	1747	438/459.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 17:05
S49	490	438/311.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 17:05
S50	758	438/756.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 17:05
S51	5263	S47 or S48 or S49 or S50 or S22	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 17:05
S52	11723520	@pd>="20070511"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2011/12/12 17:05
S53	1859	S51 S52	US-PGPUB;	AND	ON	2011/12/12

| | | | USPAT;
USOCR;
FPRS;
EPO; JPO;
DERWENT;
IBM_TDB | | | 17:05 | |

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